

FIG. 1

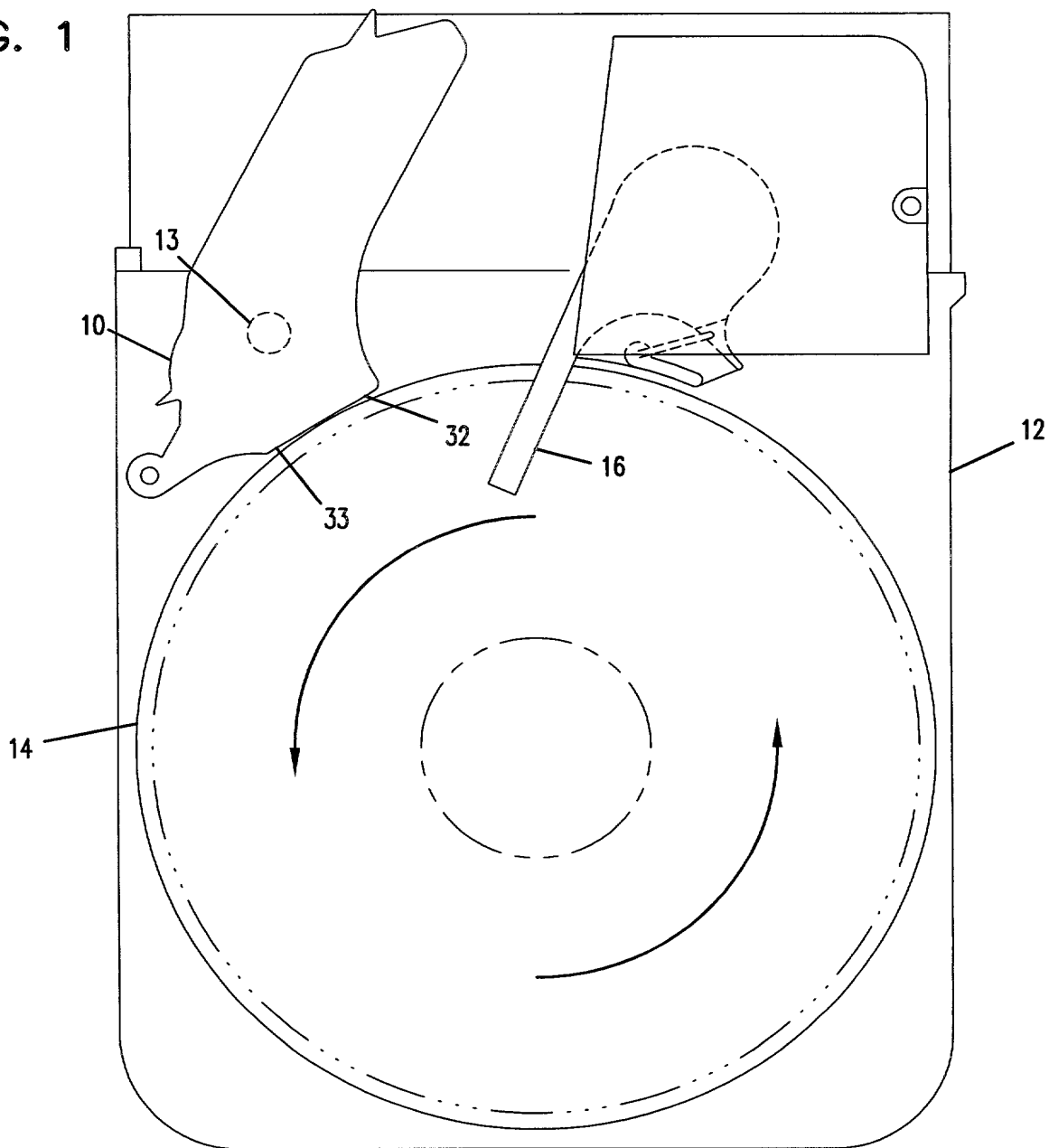


FIG. 2

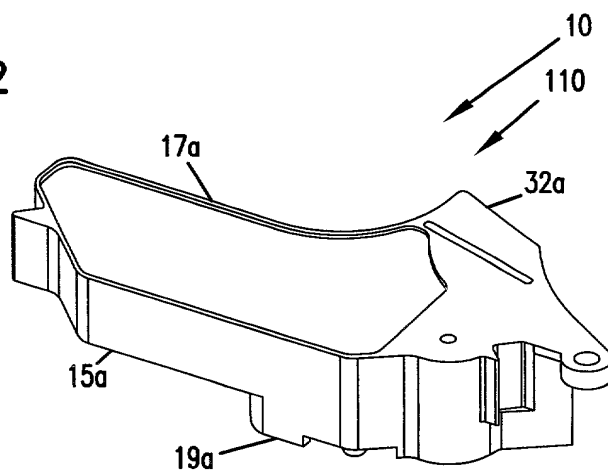


FIG.3

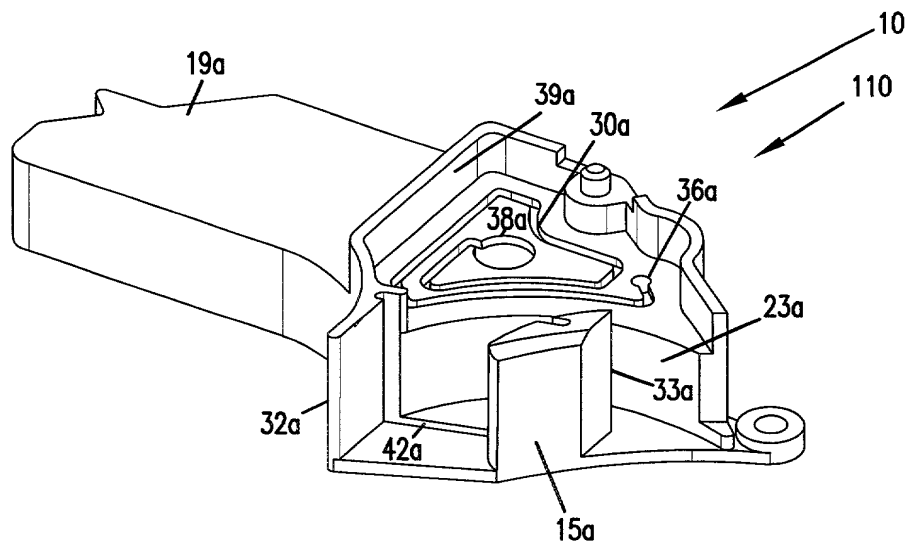
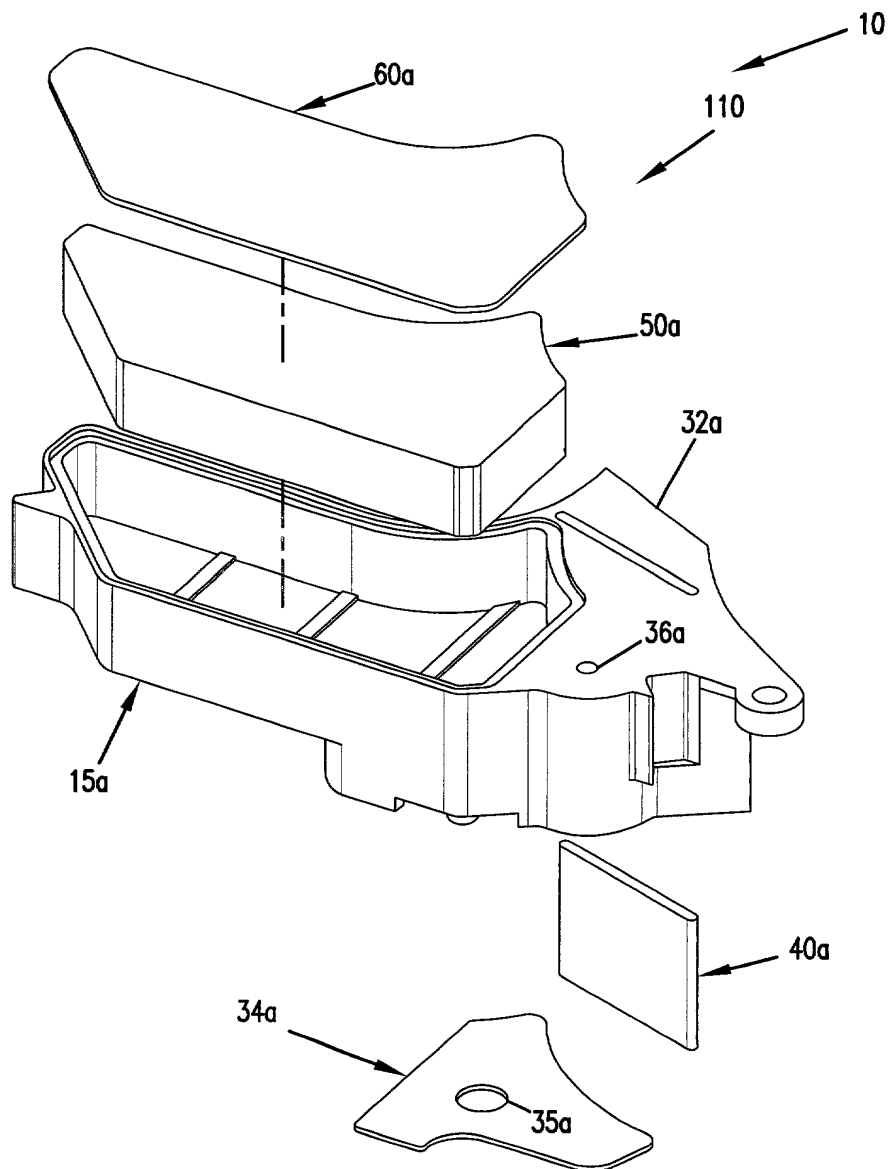


FIG.4



[illegible]

**FIG. 6**

FIG. 6 is a cross-sectional view of a device 10. The device includes a substrate 15b with a top layer 17b and a bottom layer 19b. A central component 23b is mounted on the substrate. A dashed line 210 indicates a cross-section through the device. Other components labeled include 30b, 34b, 36b, 38b, 40b, 50b, and 60b.

FIG.7

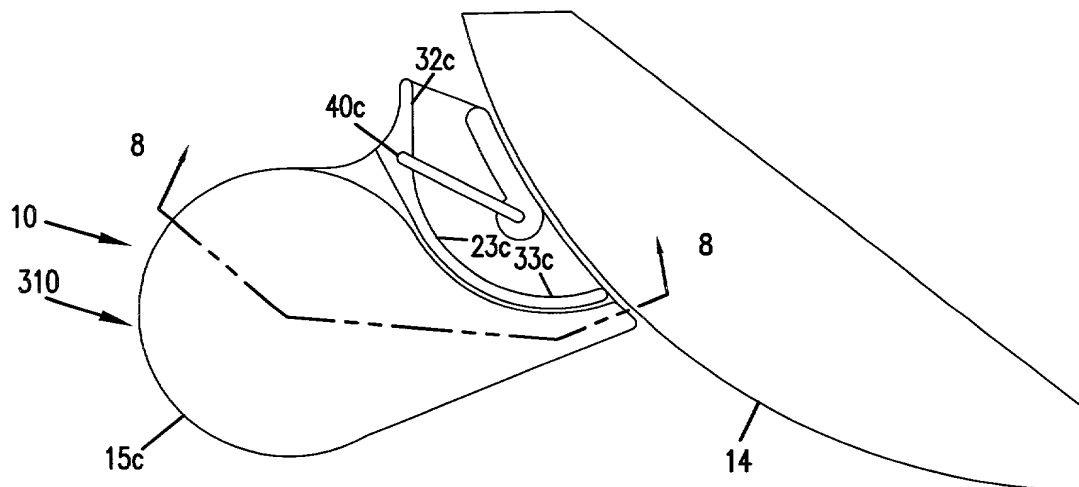


FIG.8

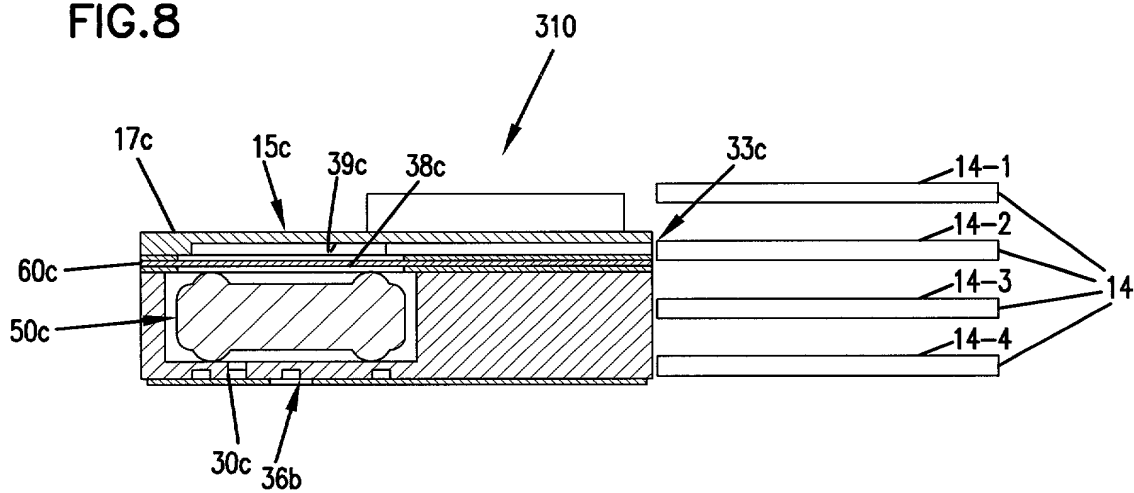


FIG.9

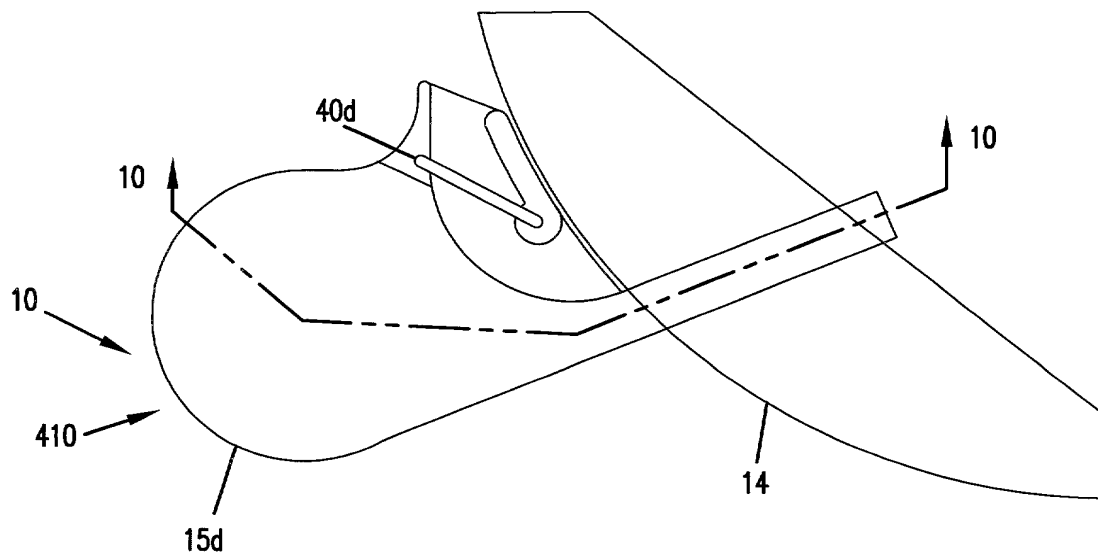


FIG.10

